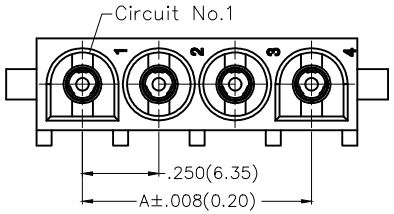
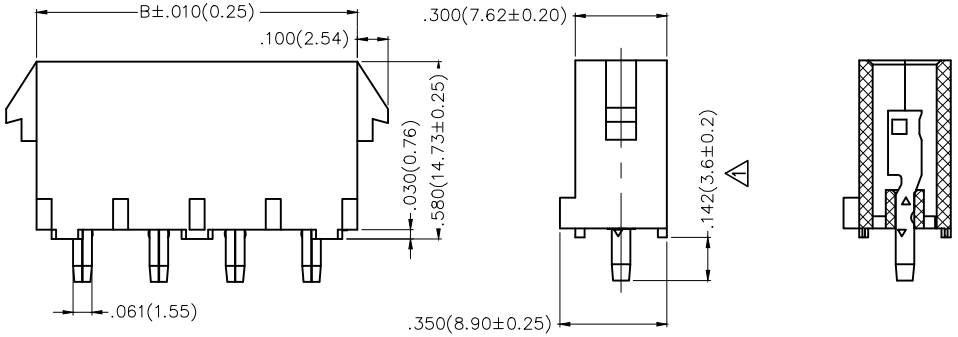
REV	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD
1	⚠1	Size change	01/AUG/19	KATE	CHERRY

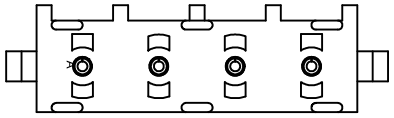


Electrical
- Current Rating: 15A AC(rms)/DC
- Voltage Rating: 600V AC(rms)/DC
- Contact Resistance: 10 mΩ Max
- Insulation Resistance: 1000 MΩ MIN
- Withstanding Voltage: 5000V AC r.m.s
- Temperature Range–Operating: –40°C~+105°C

Material and Plating
- Housing: PA66(UL 94V–2)
- Contact Pin: Brass
- Plating: Tin Plated



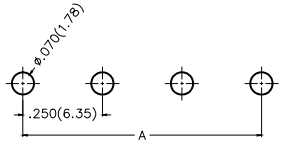
Circuits (n)	Part No.	Dimensions(in/mm)	
		A	B
2	FWF63504–S02S22W1B	.250(6.35)	.550(13.97)
3	FWF63504–S03S22W1B	.500(12.70)	.800(20.32)
4	FWF63504–S04S22W1B	.075(19.05)	1.050(26.67)
5	FWF63504–S05S22W1B	1.000(25.40)	1.300(33.02)
6	FWF63504–S06S22W1B	1.250(31.75)	1.550(39.37)
8	FWF63504–S08S22W1B	1.750(44.45)	2.050(52.07)



Ordering Information

FWF 635 04 — S XX S 2 2 W1 B
1 2 3 4 5 6 7 8 9 10

1	Category: FWF–Wafer	2	Series Number: 635–Pitch6.35mm	3	Distinction No.: 04	4	Row Option: S–Single Row	5	Circuits: XX
6	Entry Angle: S–180° Vertical	7	Plating: 2–Tin Plated	8	Material–Resin: 2–PA66	9	Color–Resin: W1–White	10	Packaging: B–PE Bag



Recommended P.C.Board Layout

THIRD ANGLE PROJECTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY: FRANK	DATE: 28/JUN/13	PART NO.: FWF63504–SXXS22W1B / ITEM NO.: FWF63504
DESIGN UNITS: Inch (metric)	X.±.012(0.30)	X.°±5°	CHECKED BY: JACOB	DATE: 28/JUN/13	TITLE: Wire to Board (Wafer) Pitch 6.35mm 180° Vertical (DIP)
	X.X±.008(0.20)	.X°±2°			
SCALE: 5:1	X.XX±.006(0.15)	.XX°±1°	DRAWN BY: CHERRY	DATE: 28/JUN/13	REV 1 / SHEET NO. 1/1
SIZE: A4	X.XXX±.004(0.10)	.XXX°±0.5°			

TXGA Leader Of Industry

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